ST18930/31

DIGITAL SIGNAL PROCESSOR

 80 ns INSTRUCTION CYCLE TIME * (1.2 μ CMOS technology)

SGS-THOMSON MICROELECTRONICS

- PARALLEL HARVARD ARCHITECTURE
- SEPARATED PROGRAM AND DATA BUSES
- THREE DATA BUSES STRUCTURE
- DUAL EXTERNAL BUSES
- ONE CYCLE 16-BIT R/W OPERATION ON EX-TERNAL DATA MEMORY
- THREE DATA TYPES : 16-BIT REAL, 32-BIT REAL, 16 + 16-BIT COMPLEX
- HARDWARE MASKABLE INTERRUPT
- COMPLEX MULTIPLIER
- 320 x 16-BIT INTERNAL RAMs, 512 x 16-BIT IN-TERNAL COEFFICIENT ROM
- 3 K x 32-BIT WORDS OF INTERNAL PRO-GRAM ROM
- LOW POWER MODE
- REALTIME EMULATION OF ST18930 ROM VERSION WITH ST18931 ROMLESS VER-SION

DESCRIPTION

The ST18930/31 HCMOS digital signal processors are members of SGS-THOMSON family of general purpose DSP's fully software and hardware compatible with previous members of the family.

By virtue of their highly parallel architecture, these digital signal processors are well suited to a wide range of applications including those requiring operations on complex numbers.

Typical examples are found in telecommunications, modems, image and speech processing, high speed control, digital filtering, sonar and radar applications.

They are able to execute simultaneously within 100 ns an ALU function, a Multiplication, two Read and one Write operations with associated address calculation.

The on-chip large memory resources and multiprocessor direct interface allows the development at the lowest cost/complexity of high performance applications. The ST18931 is the ROMless version of the ST18930. In addition of the ST18930 features, it provides the capability of addressing

December 1988

* Also available 100 and 160 ns cycle time versions.

up to 64Kx32-bit external instruction memory and allows a total realtime emulation of the ST18930. It is also particularly well adapted for applications where large program memory is required or for low quantities.

DEVELOPMENT SYSTEMS

The ST18930 is supported by a complete set of hardware and software tools for applications development. Software packages include assembler, linker and simulator on VAX and PC as well as a high level "C" compiler and optimizer.

Hardware tools include a stand-alone emulator, eprom emulation module and a powerful multiprocessor development station.

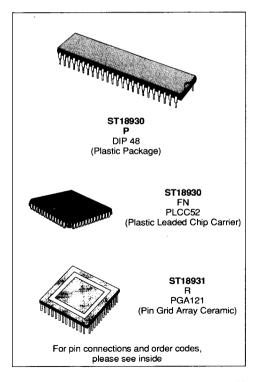


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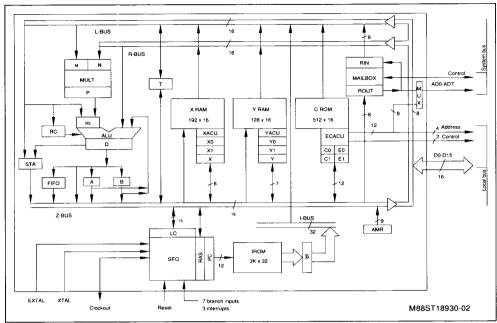
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1. BLOCK DIAGRAM (ST18930)



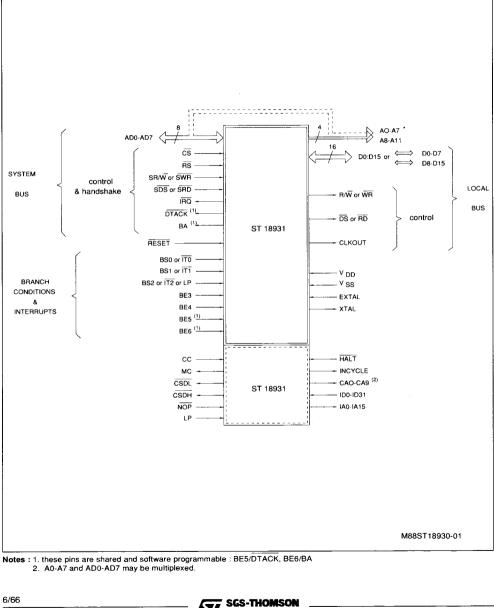
DEFINITION OF ACRONYMS

L-bus	: Left data bus	CROM	: Coefficient ROM
R-bus	: Right data bus	X0, X1, X	K : Addressing registers XRAM
М	: Multiplier input register	Y0, Y1, Y	Y : Addressing registers YRAM
N	: Multiplier input register	C0, C1	: Addressing registers CROM
Р	: Multiplier output register	E0, E1	: Addressing registers ERAM
BS	: Barrel Shifter	XACU	: Address calculation unit XRAM
ALU	: Arithmetic and Logic Unit	YACU	: Address calculation unit YRAM
D	: ALU output register	ECACU	: Address calculation unit CROM & ERAM
RC	: Replace Code register	RIN	: Input register of mailbox
STA	: Status register	ROUT	: Output register of mailbox
FIFO	: ALU output FIFO	AMR	: Access mode register
Α	: ALU accumulator	IR	: Instruction register
в	: ALU accumulator	PC	: Program counter
Z- bus	: Result data bus	RAS	: Return address stack
т	: Transfer register	SEQ	: Sequencer
XRAM	: X Data RAM	LC	: Loop Counter
YRAM	: Y Data RAM	IROM	: Instruction ROM



2. PIN DESCRIPTION

Figure 1 : Input/Output Pins.



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LECTRONICS

LOCAL INTERFACE

Name	Pin Type	Function	Description	
D0-D15	I/O	Data Bus	Can be concatenated or separate D (0:7), D (8:15).	
A8-A11	0	Address Bus	High order addresses for local interface (RAM).	
DS or RD	0	Data Strobe/Read	ad Synchronizes the transfer on local bus/read cycle.	
R/W or WR	0	Read/write/Write	Indicates the current bus cycle state/write cycle.	
CLKOUT	0	Clock Output	Frequency programmable from EXTAL + 2 to EXTAL + 16.	
A0-A7	I/O	Address Bus	Low order addresses for local interface (RAM).	

SYSTEM INTERFACE

Name	Pin Type	Function	Description
AD0-AD7	1/0	System Data Bus	System data bus for exchanges between the processor and a host via the mailbox.
cs	I	Chip Select	Used by a host to gain access to the mailbox and system bus.
RS	1	Register Select	Used by a host to gain access to the mailbox and system bus.
SD <u>S</u> or SRD	1	Data Strobe/read	Synchronizes the transfer on the system bus/read cycle.
SR/W or SWR	I	Read/write/Write	Indicates the current system bus cycle state/write cycle.
DTACK	0	Data Transfer Acknowledge	Indicates that the processor has recognized the access data transfer.
BA	0	Bus Available	Indicates the availability of the sytem bus to the host.
IRQ	0	Interrupt Request	Handshake signal sent to the host to gain access to the mailbox.

EXTERNAL BRANCH CONDITIONS AND INTERRUPT

Name	Pin Type	Function	Description
BS <u>0-BS2</u> or IT0-IT2	1	Branch on State Interrupt	External Branch Conditions. (low power mode through BS2 see 3, 6, 4) Interrup Input Pins
BE3-BE6*	1	Branch on Edge	External conditions. Falling edge is memorised and reset when tested.

* BE5 shares pin with BA BE6 shares pin with DTACK

OTHER PINS

Name	Pin Type	Function	Description
EXTAL	1	Clock	Are used for crystal oscillator ; if crystal oscillator is not used, pin XTAL
XTAL	0	Clock	is not connected.
VDD	1	Power Supply	
VSS	1	Ground	
RESET	1	Reset	
LP	1	Low Power	Active at high state. Freezes the circuit operation.



Name	Pin Type	Function	Description	
ID0-ID31	I	Instruction Data	Instruction Data Bus	
IA0-IA15	0	Instruction Address	Instruction Address Bus	
CA0-CA9	0	Coef. ROM Address or External RAM Address	External coefficient ROM address 10 bit or External RAM address (9-bit address – output enable signal) (8-bit address)	
HALT	I	Halt Signal	Halts the processor. This signal freezes the program and loop counters	
INCYCLE	0	Instruction Cycle Clock	A transition from low to high indicates that a new instruction is processed	
NOP	I	Hardware NOP	Force NOP instruction for development system.	
CSDL CSDH	0	Bus Low Z Control	$\rm D0-\rm D7$ (CSDL) and $\rm D8-\rm D15$ (CSDH) are data valid control pins for external buffers	
CC	I	Clock Cycle Control	Machine cycle = 2 T_c (EXTAL) or 4 T_c (EXTAL)	
MC	0	Master clock	EXTAL + 2 Output	

3. FUNCTIONAL DESCRIPTION

3.1. GENERAL ARCHITECTURE

The ST18930/31 architecture is based upon the innovative architectural concepts already proven in the previous members of SGS-THOMSON digital signal processors family.

Therefore, the compatibility is kept at object code level with the TS68930/31.

The ST18930/31 confirm the efficiency of a highly parallel and pipelined operation using a true Harvard memory space and bus structure. This efficiency is there improved by the advanced 1.2 μ HCMOS technology providing 80 ns instruction cycle.

The block diagram shows four main blocks :

. The sequencer block

. The operating unit (ALU, Multiplier and Barrel Shifter)

. The data memories

. The inputs/outputs

These four blocks can be considered as four independent units working in parallel and communicating through a network of 16/32 - bit buses.

By taking advantage of the 32 - bit wide instruction bus, the ST18930/31 are able to execute simultaneously the following operations during each 80 ns machine cycle :

. Read two operands from internal or external memory . Execute a multiplication

. Perform an ALU operation

- . Write a result into internal or external memory
- . Post modify three pointers independently
- . Store data into the transfer register

In addition, data exchanges through mailbox occur concurrently and independently of internal operations.

All instructions are executed in a single cycle time except branch instructions.

Some additional features give the ST18930/31 extremely powerful performances. They provide three operating modes (real, complex and double precision) dynamically set by software and user transparent.

In complex mode, the hardware multiplier provides (16 + 16 - bit) results from 2 x (16 + 16 - bit) inputs each machine cycle.

(25 - million multiplications per second).

The ALU, reinforced by a barrel shifter, provides 30 basic arithmetic and logic functions.

Three dedicated calculation units control the four data memory spaces.

A large 3Kx32 (96Kbits) program ROM (for the ST18930) enlarge the usual digital signal processor applications possibilities, using the efficiency of the



code and architecture. The following sections will detail all the hardware blocks of the ST18930/31 and demonstrate its software performances provided by the high level of parallelism in the operations.

3.2. OPERATING UNIT

One of the most useful features of the ST18930/31 is to provide the user three operating modes which can be dynamically set by software.

These three modes are :

. REAL 16 - bit

. COMPLEX 16 - bit real + 16 - bit imaginary

. DOUBLE PRECISION 32 - bit

Thus, the DSP is seen by the user as a standard 16 - bit real or complex machine or a 32 - bit real machine. All operating units and working registers are automatically adjusted by the processor to the right length. In real mode, all instructions are executed in a single machine cycle. In complex and double precision mode, the instruction time is doubled.

In all modes, the number representation used is signed 2's complement.

3.2.1. 16/32 - Bit ALU/Accumulator (fig. 2). The ALU can be seen either as a 16 or 32 - bit ALU. The ALU is loaded on the right side by the R - bus or by the A or B accumulators.

On the left side, the operands always access the ALU through the barrel shifter, coming either for the L (left) - bus or the hardware multiplier output register P.

The result of an ALU operation is automatically written in the D register and, if required into the Accumulator or FIFO. The ALU provides a range of 30 codes for operations which execute in a single machine cycle. They include arithmetic and logic operations, shift and rotate operations. The high degree of parallelism of the ST18930/31 processor allows more combinations than previous generation DSP devices which require a more complex instruction set.

The complete list of ALU codes and description is given in 3.8.2.

3.2.2. Barrel Shifter. The 16 - bit barrel shifter located on the left side of the ALU performs all logic/arithmetic shifts and rotations. It is used for normalization and formatting of data in floating point operations and bit or byte manipulations. Two types of operations are allowed in the barrel shifter.

- Operations defined by ALU codes (shifts of 1 or 8 bits) see 3.8.2
- Operations defined by specific dedicated instructions :

ASR $(0 \rightarrow 15)$ arithmetic shift right by N $(0 < N \le 15)$

LSR $(0 \rightarrow 15)$ logical shift right by N $(0 < N \le 15)$

LSL $(0 \rightarrow 15)$ logical shift left by N $(0 \le N \le 15)$

ROR (0 \rightarrow 15) rotation right by N (0 < N \leq 15)

In complex mode, the barrel shifter performs the same operations on complex and imaginary part.

3.2.3. Multiplier. The multiplier executes a 16 x 16bit multiplication with a 32-bit result at each machine cycle. The operands are loaded into the M and N registers and the result of a previous multiplication is written in the P register during the same cycle.

The pipeline structure makes the multiplication result available with a delay of two instruction cycles.

The multiplier provides a multiplier overflow flag OVFM which is memorized in the status register in complex mode only (see 3.2.4).

The efficiency of the parallel pipeline operation of the multiplier is shown in fig. 3.



Figure 2 : Alu Block Diagram.

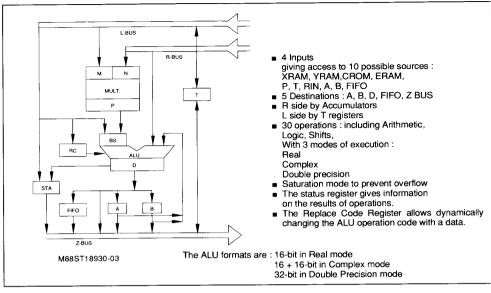
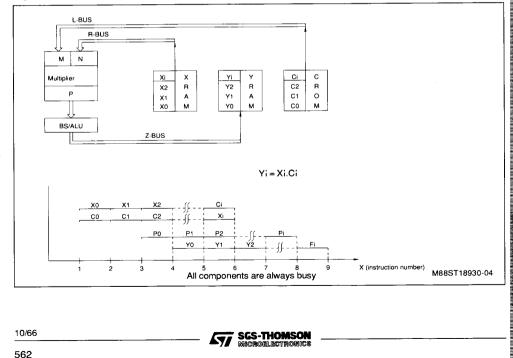


Figure 3 : Multiplier Efficiency.



3.2.4. Associated registers.

Registers A, B.

A and B store the results from the ALU. They are sized according to the mode of operation. They also provide capability to feedback the ALU for a new operation with the ALU result of a previous operation.

Register FIFO.

The 4 x 16-bit FIFO is used for intermediate storages. Initialization of the FIFO (empty FIFO) can be made by an INI instruction.

A result loaded in FIFO at instruction N is available at least at instruction N+2 in real mode and N+1 in complex and double precision modes.

Register RC (Replace Code register).

This register can dynamically load an ALU code to be executed by the processor from the data memories.

This register is 6-bit wide and is loaded by the $6\,MSB$ of L-bus :



Bit 1 to 5 contain the executable ALU code corresponding to the bits I21-I17. Bit 0 allows the choice of ALU output destination (A or B register).

Its contents is defined by three ALU codes : (see 5.2.)

ALU Code	Function		
RCR	Load ALU control code in register RC		
RCE	Execute ALU code contained in register RC		
RCER	Execute ALU code contained in RC and load new ALU code in RC		

Status register (STA).

This register provides a status of the ALU, operating and addressing modes, and multiplier. It is divided into two sub-registers :

CCR (Condition Code Register) STR (State Register)

A detailed description of this register is given in δ 5.4.

Transfer register T.

The transfer register provides a direct transfer capability between L-bus and Z-bus.

It can either be source or destination for the two buses.

Its various uses include :

- * Loop back to the multiplier in one cycle
- * Temporary register between memory and ALU
- * Temporary register between memory and multiplier
- * Operation between two accumulators in the same instruction
- * Memory to memory transfer
- * Saving program counter (in a branch instruction)



The status register content can be saved using instruction SVR.

The condition code register CCR can be read in OPIN instruction and it can be loaded via L-bus (ALU code LCCR).

The state register STR can be programmed by an INI instruction or an SVR instruction (except EF bit).

Register D.

This is an intermediate register which is loaded with ALU result at each machine cycle.

3.3. DATA MEMORY BLOCKS.

3.3.1. Available spaces. The ST18930/31 provides four separated memory spaces (see fig. 4)

. two internal RAMs of respectively 192 x 16-bit (XRAM) and 128 x 16-bit (YRAM)

. one internal data ROM (independent from the program ROM) of 512 x 16-bit (CROM) (ST18930 only)

. one optional external memory (ERAM) of 4 K x 16-bit accessible in 1 single instruction cycle in exactly the same way as internal memories.

This external memory is controlled by an Intel or Motorola type control interface and offers full speed, fully transparent, Read and Write operations.

However slower external memories or peripherals can be accessed by using slow exchanges mode.

The powerful instruction set and the Harvard architecture allows many combinations of simultaneous memory accesses. The only forbidden situations are :

- read and write access is the same RAM within the same instruction

- simultaneous access to CROM and ERAM

3.3.2. Address Calculation Units. Three different Addresses Calculation Units are available.

XACU is associated with XRAM

YACU is associated with YRAM

ECACU is associated with the ERAM and the CROM

3.3.3. Addressing modes. The ST18930/31 provides four addressing modes :

- Direct addressing
- _ Immediate operand
- Indirect addressing with or without post modification of the pointers
- Circular addressing (also called virtual shift mode) for XACU and YACU.

The circular addressing mode is of particular interest in digital signal processing typical operations like convolution algorithms used in FIR filters. It has the same function as a shift register but does not move the data stored.

For this feature, three pointers are used in the memory space chosen (X or Y). The current address is given by a specific X pointer shifting repetitively between two limits X0 and X1 (respectively Y, Y0 and Y1).

The circular mode is declared in the status register STA (see 3.2.4) by an INI instruction.

3.3.4. Pointers. The ST18930/31 offers a large number of address pointers for each memory space

- _ X0, X1 and X for XRAM
- _ Y0, Y1 and Y for YRAM
- C0, C1 for CROM
- E0, E1 for ERAM

The pointers Xi, Yi, Ci and Ei can be independently incremented, decremented or maintained. The two pointers X and Y are specific to the circular addressing mode. The pointers can be loaded with new addresses (constant or computed values) through Z-bus. In this case, the value of unused Z-bus MSBs are irrelevant. The unused bits are set to 1.

3.3.5 Odd/Even addresses. In complex and double precision modes, the processor automatically generates the two addresses necessary to store

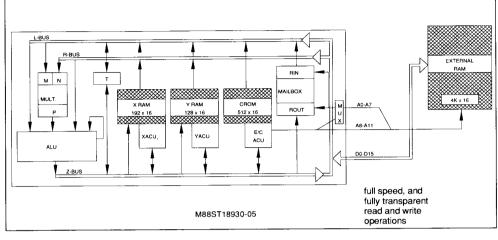
one data word (even first, then odd addresses).

The user can reverse this order by setting to 1 the ADOF bit with the INI instruction (refer to OPCODE). This feature is available independently for XRAM and YRAM.

	COMPLEX WORD	DOUBLE PR. WORD
Even Address	Real Part	Lower Part
Odd Address	Imaginary Part	Upper Part



Figure 4 : Data Memory Blocks.



3.4. SEQUENCER BLOCKS

3.4.1. Sequencer. The purpose of the sequencer is to generate the next instruction address.

The sequencer takes into account the current operating mode of the ST18930/31 to execute this task. The instruction is executed in one cycle time in real mode and two cycles time in complex or double precision mode.

The linear address program generation may be interrupted by several means hereunder described.

- A. Execution of a branch instruction
 - unconditional branch always.
 - seven ALU conditions flagged from the status register :
 - SR Sign real
 - SI Sign Imaginary
 - CR Carry Real
 - CI Carry Imaginary

- Z Zero
- OVF Overflow

MOVF Memorized overflow MOVF is reset when tested by branch instruction.

- three external conditions on state of pins BS0, BS1, BS2 (the pins BS0, BS1, BS2 can also be used as interrupt pins if enable interrupt is programmed).
- four edge sensitive external conditions on pins BE3, BE4, BE5, BE6. The falling edges of BE3-BE6 are memorized internally and reset when tested by the branch instruction. The external test conditions are used to synchronize different processes.
- The mailbox flag RDYOIN indicating mailbox availability.

All the branch conditions can be tested on true or false conditions.



ST18930/31

- B. Subroutine call
- C. Loop execution

One of the most powerful features of the ST18930/31 is its ability to repeat the execution of several instructions with very straightforward commands. The loop execution is set with the instructions : REPEAT, BEGIN, END which respectively define the number of loops, the beginning of loop and its end. The DSP will then manage all the necessary pointers to execute the loop with no overhead time (see 3.4.4.).

D. Execution of an interrupt routine

When the Enable Interrupt bit (EI) of the status register (STA) is set, a low level on any of IT0, IT1 and IT2 inputs forces the PC content at \$ 0001. Mailbox interrupts can be enabled separately from IT inputs interrupt; it occurs when a mailbox exchange has been completed (see & 3.5.6). During interrupt routines execution, the program counter is saved in the Return Address Stack (RAS).

3.4.2. Instruction ROM. The ST18930 instruction ROM has a capacity of 3072 words of 32-bit available for the user. The ROM code is defined following the user's information (see appendix C for masking information). The ST18931 does not provide an on-chip ROM memory, but can address an external 64 K program memory space in a single cycle.

3.4.3. Program Counter. The program counter is a 16-bit wide Register ; 12 bits are used in the ST18930 (ROM version).

3.4.4. Loop Counter. The loop counter does considerably increase the efficiency of the processor in repeated calculations, very commonly used in digital signal processing.

Three counters define a hardware loop :

- LCI Instruction Loop Counter (4-bit). Counts the number of instructions to be executed in the loop.
- LCR Repeat Loop Counter (8-bit). Gives the number of times the loop will be repeated (can be loaded by a calculated value).
- LCD Delay Loop Counter (3-bit). Gives the delay between the declaration and the start of a loop.

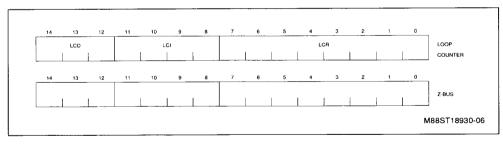
The loop counter content can be saved (SVR instruction) with the format shown in table below :

The loop counter is set by the three pseudo-instructions Begin, Repeat and End in the Macroassembler.

The loop counter is frozen during an interrupt routine.

On the ST18931, a HALT freezes the state of the loop counter. A RESET signal resets the loop counter.

3.4.5. Return Address Stack. The JSR instruction allows one level of subroutine nesting with automatic saving of the PC on to the Return Address Stack. Multiple Level of subroutine nesting can be implemented in RAM using either of the two pointers as stack pointer.





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3.5. INPUTS/OUTPUTS

A very important feature of a signal processor is its ability to be inserted in a complete system including memories, other processes, analog interface circuits.

Basically, the external world seen by a ST18930/31 can be divided in two main sections : communications with its own local resources (peripheral, memories, converters) and communications with control processor, either microcontroller or master DSP in a multiprocessor application.

To communicate with its local resources, the ST18930/31 uses its local bus.

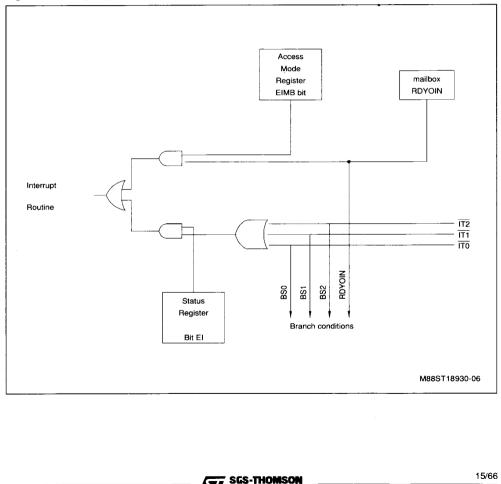
Figure 5 : Interrupt Inputs and Conditions.

To interface with a host, the ST18930/31 uses its system bus and interrupt/branch capabilities.

However, the local and system bus configuration is flexible and allows many combinations for the architecture of a system based around a ST18930/31.

3.5.1. Interrupt branches. Several sources of interrupt and branch conditions are accepted by the ST18930/31. Depending on the initialization (INI) the ST18930/31 can accept interrupts from pins, ITO, IT1, IT2. It can also and independently accept software interrupts transmitted through the mailbox.

The various sources/conditions of interrupts are summarized in fig. 5 :



3.5.2. Dual bus interface. In order to provide the maximum flexibility, the ST18930/31 provides two buses. One is called the system bus and is found on pins AD0-AD7, the other one called local bus is situated on pins D0-D15. The system bus provides a very straightforward interface to a host controller, while the local bus allows the ST18930/31 to make an efficient use of external resources such as memories, analog interface circuits etc... This dual bus structure allows many combinations of circuits where the ST18930/31 can act in different ways :

Fig. 6A as a microprocessor peripheral

Figure 6 A : HOST/ST18930.

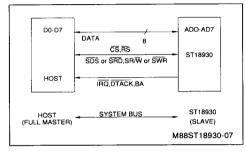


Figure 6 C : HOST/ST18930/RAM.

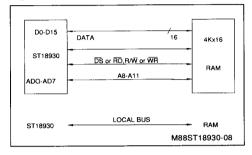
Fig. 6B as a processor with its associated memory

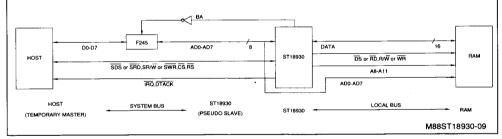
Fig. 6C as an intelligent peripheral having its own external memory and connected to a microprocessor.

It must be emphasized that, in most configurations, the connections are absolutely direct and do not use any external additional logic.

Furthermore, thanks to the dual bus structure, several ST18930/31 can be very simply combined together in multiprocessor applications, thereby directly increasing the processing power.

Figure 6 B : ST18930/RAM.





3.5.3. Host/slave configuration. The processor acts as a host on its local bus and as a slave on its system bus.

In configurations in which the ST18930 accesses external RAMS on its local bus, pins AD0-AD7 can be used to provide 8 LSB addresses, while A8-A11 provides 4 MSB addresses to the RAM.

In this case, the ST18930/31 prevents the host from using the system bus and is then called a pseudo-slave.

Since the host can only temporarily access the system bus it is defined as a temporary master. That mode of operation is software controlled through the Access Mode Register (AMR) (see 3.5.7.).

On the ST18931 the pins CA0-CA7, which present the least significant bits of external ERAM/CROM addresses can be connected to that RAM in place of system bus pins AD0-AD7.



3.5.4. Local bus. The local bus uses two software programmable signals to control the data on D0-D15.

DS : Data Strobe. Synchronizes the transfer on local bus.

B/W · Bead/Write. Indicates the direction of the data.

These signals are used for Motorola-like bus compatibility.

Figure 7 : Local Bus Pin Description.

- D0-D7 16 hit data bus can be concatenated or separate - D8-D15 4 address hits A8-A11 ST18930 - R/W or WR Control bits. Can be chosen among 2 sets - DS or BD Additional adress bits (in pseudo-slave mode) M88ST18930-10

The four address bits of the local bus are usually sufficient to address peripherals. When an access to external RAM is necessary with the ST18930/31. the address bus can then be extended by using the AD0-AD7 pins of the system bus as address lines.

If an external peripheral or external memories are too slow to answer in one machine cvcle. the ST18930/31 can be programmed to execute an external access in several cycles (2, 3 or 4) using the bits ES0 and ES1 of Access Mode Register (see 3.5.7.).

This mode is particularly useful for peripherals such

PSEUDO

SI AVE

TO OTHER SLAVES D8-D15 A11 A10 $D_0 - D_7$ $D_8 - D_{15}$ ST18930 MASTER Selection High Impedance 0 0 ADD-AD7 ٥ 1 High Impedance Selection D0-D7 Selection 1 0 High Impedance ST18930

RAM

DATA

1

1

M88ST18930-11

High Impedance

Selection

Figure 8 : Separate Local Buses.

RD : Read, Read clock pulse.

WR : Write, Write clock pulse.

These signals are used for Intel-like bus compatibilitv.

A8-A11 : Address bits (4)

AD0-AD7 : Optional additional address bits (8)

as data converters, or dedicated interface like the MAFE chip set (Modem Analog Front End) from SGS-THOMSON.

The local data bus can also be splitted into two independent 8-bit buses. This is used in a multiprocessor architecture when a pseudo-slave uses the system bus to transfer its own RAM addresses on D0-D7 (fig. 8). By dividing its local bus, the temporary master can remain a full-master on bus D8-D15 and does not require a bus transceiver on D0-D7. The selection between the two buses is then made by the addresses A10-A11 as indicated in Fig. 8.



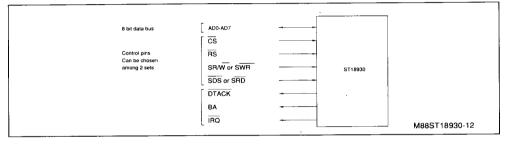
3.5.5. System Bus: The system bus uses two software programmable signals to control the data on AD0-AD7.

The system bus mode of operation (Intel or Motorola) is set by asserting the SIM Flag using an INI instruction). SR/ \overline{W} and \overline{SDS} signals are used for Motorola-like bus compatibility.

SWR and SRD signals are used for Intel-like compatibility.

CS/RS	Mailbox control signal. Also used by a host to gain access to the bus.
SR/W or SWR SDS or SRD	System Read/Write) Generated by an external processor (host) System Data Strobe)
IRQ	Handshake Signal (see 3.5.6)
DTACK	Data Transfer Acknowledge. Compatibility with 68000 family. Is programmed by Access Mode Register.
BA	Bus Available. The ST18930/31 is not currently using the system data bus to generate addresses. BA is also programmable by the Access Mode Register.

Figure 9 : System Bus Description.



3.5.6. Mailbox. The mailbox is a set of registers which interface with the system data bus. The mailbox is divided in two parts :

- RIN (3 x 8 bit register) : This register is read internally by the ST18930/31 on the upper byte of Lbus (L8-L15) and written externally from the system bus. After each write or read operation the data is shifted by one byte.
- ROUT (3 x 8 bit register): This register is written internally with the upper byte of the Z-bus (Z8-Z15) and read externally on the system bus. After each operation (read or write), the data is shifted by one byte.

protocol signal description.

RDYOIN.

Internal flag indicating the status of the mailbox

- 0 = DSP has access to the mailbox
- 1 = host has access to the mailbox
- a. RDYOIN is set by the DSP and reset by the host. That means that the DSP gives the mailbox to the host when it finishes using it and vice-versa. In no case can the host or the DSP take possession of the mailbox, it can only wait for the other to give it back.

- b. The ST18930/31 sees RDYOIN as a flag :
 - _ tested by a branch instruction
 - set to 1 by an initialization instruction in order to give the availability of the mailbox to the host.

IRQ.

Handshake signal enabling the host to gain access to the mailbox.

- IRQ is asserted low by the DSP to indicate the availability of the mailbox (at the same time as RDYOIN).
- b. The host after testing IRQ, knows that it can access the mailbox. The access to the bus (which can be currently used by the DSP as a local address bus) must be requested by reading the address CS = 0, RS = 0.
- c. The DSP then answers back by asserting IRQ high. (In pseudo-slave mode, the DSP is halted). The host now has full control of the bus and mailbox.

When the host has completed the exchange it generates the address CS = 0, RS = 1 and the DSP resets RDYOIN.



HALT (internal).

The internal halt has the following effect on the circuit :

- the program is stopped at the end of the current instruction, the program and loop counter are frozen
 a NOP is executed
- no more addresses are generated on the system bus

in the slave. The two slave address pins (CS, RS)

Therefore, the slave is seen as two external memo-

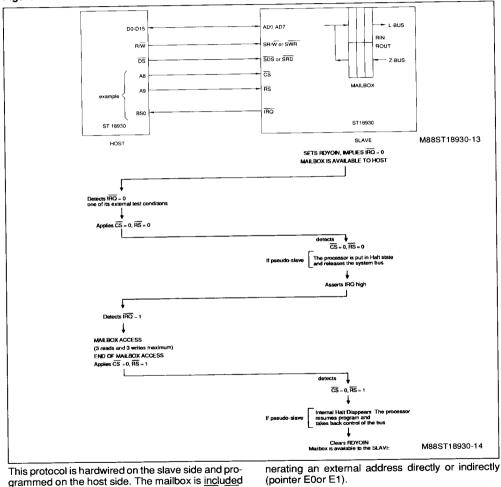
are directly connected to two host address lines.

Figure 10 : Mailbox Connection and Protocol.

MAILBOX INTERRUPT.

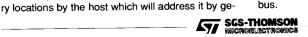
Enabled by initializing the bit EIMB of Access Mode Register (AMR). When RDYOIN is reset, the PC is forced to address \$ 0001.

Refer to figures 11.A and 11.B for timing detail of mailbox protocol.



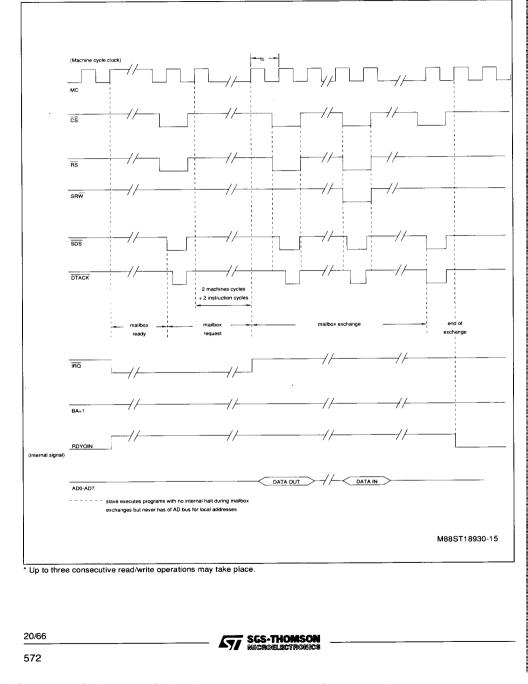
By addressing the location 00 the host echoes the IRQ to the slave and accesses the mailbox.

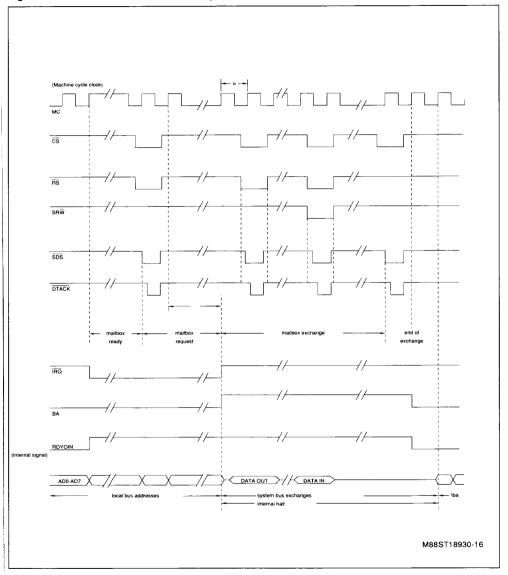
By addressing the location 01 the host releases the bus.

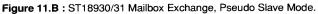


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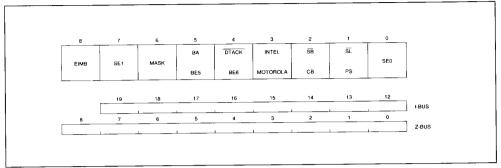
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SGS-THOMSON MICROELECTRONICS **3.5.7. Access Mode Register (AMR).** The AMR is a 9-bit register which defines the processor external access modes.

It is loaded by an INI or SVR instruction and saved by an SVR instruction. Its fields are defined as follows :



Bits 0 and 7 - SE0, SE1.

These two bits define the number of cycles fixed by the user to access external resources. If the user defines a multicycle exchange (i.e. for access to slow memories), internal wait states are automatically inserted allowing the processor to wait for the completion of the external exchanges. The instruction executes once with the number of cycles chosen by the programmer.

Multicycles exchanges can be programmed in any operating mode (real, complex or double precision).

SE1	SE0	Number of machine cycles for external access
0	0	1
0	1	2
1	0	3
1	1	4

Bit 1 : SL/PS.

0 = Slave.

1 = Pseudo-slave.

This bit defines the behaviour of the ST18930/31 regarding the system bus (AD0-AD7). In slave mode, the processor will never use the system bus as local bus address.

In pseudo-slave, the processor uses address bus (AD0-AD7) for local resources. These bits are concatenated with A8-A11 to form a 12-bit address bus.

Bit 2 : SB/CB.

0 = Separated bus.

1 = Concatenated bus.

This bit indicates whether the local bus is used as a 16-bit concatenated bus or as 2 independent 8-bit buses.

(see 3.5.4. - local bus description).

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Bit 3 : I ntel/Motorola type local bus

0 = Control pulses Read (\overline{RD}) and Write (\overline{WR}) are generated. This is the case with an Intel type peripheral or a standard byte-wide <u>RAM</u>.

1 = Control pulses data strobe (DS) and Read/Write (R/W) are generated.

This is the case for exchanges with a slave processor, a Motorola type peripheral, a data converter such as the TS7542 or the M.A.F.E. chip set (TS68950/51/52).

Bit 4 : DTACK/BE6.

0 = DTACK function. The ST18930/31 does acknowledge correct access by generation of a DTACK output.

1 = BE6. An external test condition is available on pin BE6.

Bit 5 : BA/BE5.

0 = Configurates the pin (BA)5 as bus available output indicating the availability of the system bus.

1 = Pin BE5 is used for external test conditions.

Bit 6 : MASK (ST18931 only).

0 = An external Halt applied to the processor will not change the values in the AMR register.

1 = During external Halt applied to the processor the AMR register is forced to following configuration : one cycle exchange, pseudo-slave, concatenated bus, RD and WR control pulses.

This bit can be modified by the programmer even while the HALT is asserted.

Bit 8 : EIMB.

Enables interrupt mailbox. When set to 1, this bit validates the start of an interrupt when RDYOIN internal flag goes low.

This bit is programmed with an INI instruction.



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3.5.8. Instruction interface and system control (ST18931 only). On the ST18931, the coefficient ROM and the instruction ROM (CROM & IROM) are external. The device provides the necessary buses to access these data. Instructions are read on ID0 : ID31 using IA0-IA15 for addressing. Coefficients are read on local address bus D0-D15 using CA0-CA8 for addressing. CA9 is at low level for address validation. CA0-CA7 also contains external RAM addresses (if necessary) associated with a high level for CA9.

So, for the ST18931, there is no need of a pseudo slave mode as AD0-AD7 remain available for data transfer on the system bus. Clock signals are also provided fo<u>r interfacing purposes</u> (3.6.1.). Controls signals on CSDL and CSDH indicates data transfers on D0-<u>D7 and D8-D15</u> respectively when at a low level. A NOP control input is also provided on ST18931 to allow hardware simplification of development systems. This input forces a NOP instruction when low and forces all addresses in high impedance state.

3.5.9. Halt (ST18931 only). The external HALT signal will freeze the program counter, the loop counter and the multiplier. The instruction register can then be loaded from an external source. This signal is used for system development.

3.6. OTHER RESOURCES

3.6.1. Clock generators. Three different clock outputs are available on the ST18931 and one on the ST18930.

CLKOUT : available on ST18930 and ST18931.

INCYCLE and MC (master clock) : available on ST18931 only.

The internal processor cycle is equal to the frequency of the EXTAL input divided by 2 or 4. The choice of the dividing factor is done by option at the masking level for the ST18930 and by control of CC input on the ST18931. If CC = 1 then the dividing factor is 2, if CC = 0 it becomes 4 for TS68930/31 compatibility.

The CLKOUT output period is function of the EX-

TAL period and the value of CRR register programmed by INI instruction.

CRR (3; 0)	CLKOUT/EXTAL RATIO	
1	2	
2	3	
15	16	

The INCYCLE output is equal to instruction cycle. The MC output period is equal to half of EXTAL period.

3.6.2. Reset. The reset signal acts on several processors blocks as follows :

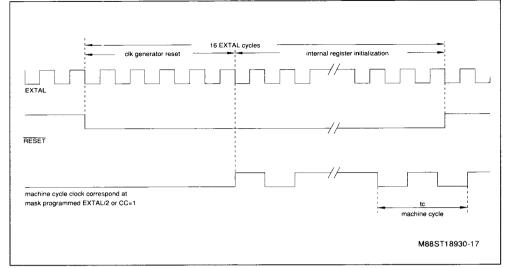
- Sequencer : the program counter (PC) and the loop counter (LC) are cleared to zero. The instruction register is loaded with NOP instruction.
- Status register : set in real mode, no saturation, empty FIFO (EF = 1), overflows (MOVF = AOVF = OVFM = 0), interrupt disabled (EI = 0), and XRAM and YRAM in non circular addressing mode.
- Access Mode Register (AMR) : set for one cycle external exchange, slave mode, concatenated bus, RD and WR, BE5 and BE6.
- Motorola mode is set on system bus.
- Mailbox control is disabled.

The reset signal must be maintained for a minimum of 16 cycles of EXTAL signal (see fig. 12 for timing). If machine cycle = EXTAL \div 2.

3.6.3. Watchdog capability (ST18930 only). The watchdog prevents the processor from staying locked in an undesired state or internal loop caused by adverse conditions. The circuitry does include a 2-bit counter which is incremented by each falling edge on BE3 input and reset by software testing of the BE3 condition. If three falling edges of BE3 input occurs without a test of the condition, the ST18930 is reset by the watchdog circuit. This capability is a mask option of the ST18930.



Figure 12 : Reset Timing.



3.6.4. Low power mode. The low power mode freezes the circuit operation and divide by 16 the internal clock generator frequency (see masking options).

In this mode, the DSP will use typically less than 5 mA.

The access to this mode can be done by software or hardware.

- Hardware mode :

On the ST18931 and the ST18930 in PLCC 52 package the LP pin forces the low power mode.

For the ST18930 in 48 pin package, the BS2 pin can be configurated by a mask option as a low power mode input pin. In this case, if the bit El of the status register is set to 1, BS2 pin will work as low power control pin, and

If EI = 0, BS2 will work as a branch condition pin.

- Software mode :

The low power mode is activated by an INI instruction.

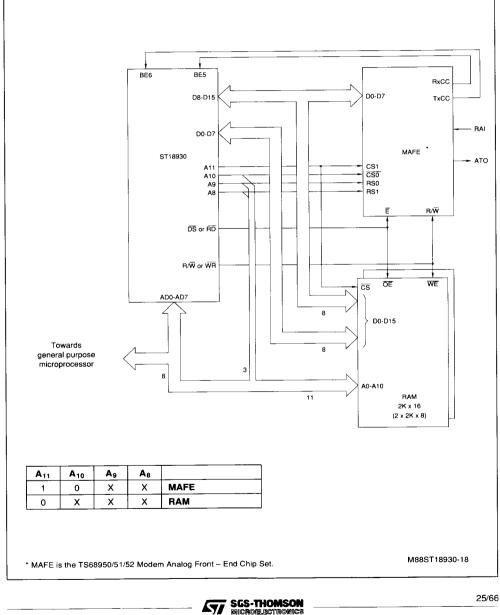
The return from low power mode is obtained with a reset or an interrupt.



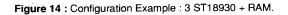
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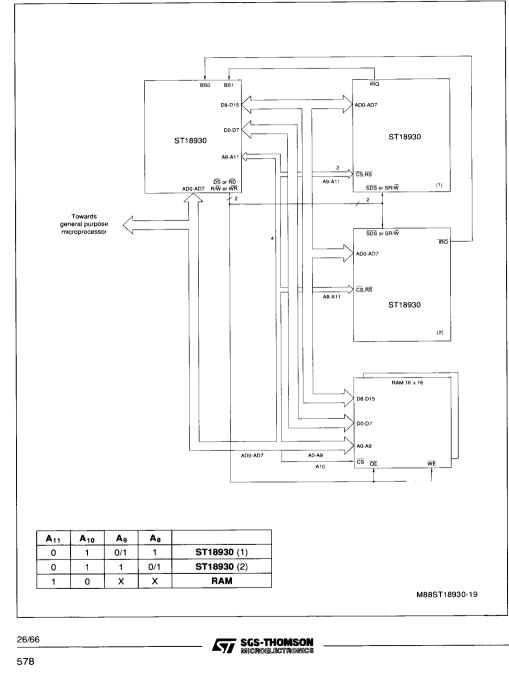
4. TYPICAL APPLICATION CONFIGURATIONS

Figure 13 : Configuration Example with ST18930 + RAM + MAFE*.









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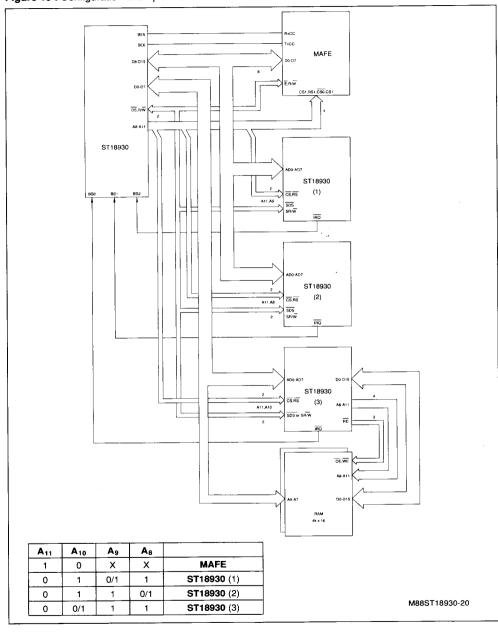
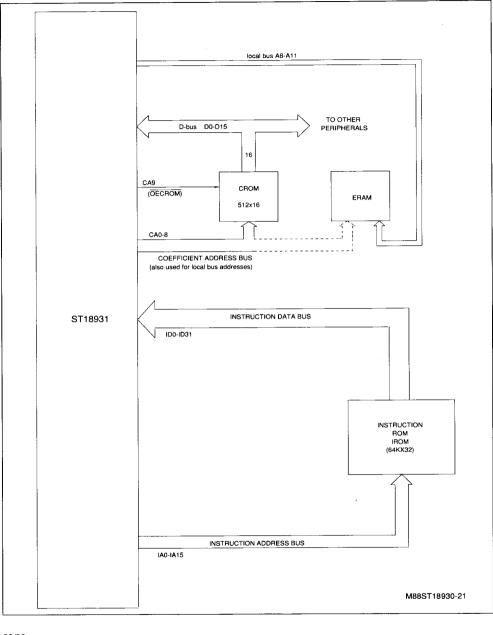


Figure 15 : Configuration Example 4 ST18930 + MAFE + RAM.

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Figure 16 : Interfacing CROM, IROM to ST18931.





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5. INSTRUCTION SET

			Number	of Cycles
Symbol	Туре	Operation	REAL	CPLX DBPR
OPIN	Calculation Instruction with Indirect Addressing	This instruction refers to operands indirectly addressed.	1	2
OPDI	Calculation Instruction with Direct Addressing	The operand sourcing the L-BUS is directly addressed.	1	2
OPIM	Calculation Instruction with Immediate Operand	An immediate operand is read on R-BUS.	1	2
ASR ASL LSR ROR	General Shift Instruction	The operand sourcing the L-BUS can be shifted/rotated by $0 \rightarrow 15$ bits.	1	2
BRI	Immediat Branch Instruction	Conditional/unconditionnal branch to direct address.	2	2
BRC	Computed Branch Instruction	Conditional/unconditional branch to computed address.	2	2
SVR TFR	Data Transfer Instruction	This instruction is used to save register contents in external or internal RAM.	1	2
INI	Initialization and Control Instruction	Pointers, acces mode register, loop counter, mode initialization, interrupts.	1	2



INSTRUCTION SET LANGUAGE DEFINITIONS

LDT Load L-BUS source into Transfer Register T R SRC R-BUS Source L SRC L-BUS Source SL ALU Input Selection Left Side SR ALU Input Selection Right Side ALU DST ALU Output Destination ALU CODE ALU Codes LDM Load L-BUS Source into Multiplier Input M LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T ACE Post Incrementation Pointers CROM or ERAM
L SRC L-BUS Source SL ALU Input Selection Left Side SR ALU Input Selection Right Side ALU DST ALU Output Destination ALU CODE ALU Codes LDM Load L-BUS Source into Multiplier Input M LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
SL ALU Input Selection Left Side SR ALU Input Selection Right Side ALU DST ALU Output Destination ALU CODE ALU Codes LDM Load L-BUS Source into Multiplier Input M LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
SR ALU Input Selection Right Side ALU DST ALU Output Destination ALU CODE ALU Codes LDM Load L-BUS Source into Multiplier Input M LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
ALU DST ALU Output Destination ALU CODE ALU Codes LDM Load L-BUS Source into Multiplier Input M LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
ALU CODE ALU Codes LDM Load L-BUS Source into Multiplier Input M LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
LDM Load L-BUS Source into Multiplier Input M LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
LDN Load R-BUS Source into Multiplier Input N Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
Z SRC Z-BUS SOURCE Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
Z DST Z-BUS DESTINATION ZT Load Z-BUS into Transfer Register T
ZT Load Z-BUS into Transfer Register T
ACE Post Incrementation Pointers CROM or ERAM
AY Post Incrementation Pointers YRAM
AX Post Incrementation Pointers XRAM
BRA Branch Address Source
FT False/True Condition
SVPC Save Program Counter
JDST Destination Register for J Constant
KDST Destination Register for K Constant
MODE Operating Mode
SAT Saturation Flag
ADOF Even/odd Flag
J Constant 8-bit Constant used to initialize registers
K Constant 12-bit constant used to initialize registers

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5.1 OPERATING CODE FORMATS

Bit	Field	Operations and Codes
31 30	OP CODE	00
29	LDT	0-NO LOAD, 1-LBUS \rightarrow T
28 27	R SRC	00 01 10 11 [X0] [E0] [Y0] [Y1]
26 25 24	L SRC	000 001 010 011 100 101 110 111 [X0] [X1] [Y0] RIN T [E1] [C0] [C1]
23	SL	0-LBUS / 1-P
22	SR	0-RBUS / 1-A/B (refer to ALU DST)
21 20 19 18 17	ALU CODE	cf. Special Table
16 15	ALU DST	00 01 10 11 D F A B
14 13 12	Z SRC	000 001 010 011 100 101 110 111 D F A B T CCR
11	LDM	0-NO LOAD / 1-LBUS \rightarrow M
10	LDN	0-NO LOAD / 1-RBUS \rightarrow N
9 8	ACE	00 01 10 11 + 0 + 1 1
7 6	AY	00 01 10 11 + 0 + 1 1
5 4	AX	00 01 10 11 + 0 + 1 1
3 2 1	Z DST	000 001 010 011 100 101 110 111 NONE ROUT [Y0] [Y1] [E0] [E1] [X0] [X1]
0	ZT	0-NO LOAD / 1 ZBUS \rightarrow T

Fig. 17 : OPIN : Calculation Instruction with Indirect Addressing.



Bit	Field	Operations and Codes
31 30 29	OP CODE	010
28 27	R SRC	00 01 10 11 [X0] [E0] [Y0] [Y1]
26 25 24	L SRC	000 001 010 011 100 101 110 111 X - Y RIN T E - C
23	Z SRC	0-D / 1-F
22	SR	0-RBUS / 1-A
21 20 19 18 17	ALU CODE	cf. Special Table
16	ALU DST	0-F / 1-A
15 14 13 12 11 10 9 8 7 6 5 4	LBUS DIRECT ADDRESS	MSB LSB
32	Z DST	0000 0010 0100 0110 1000 1010 1100 1110 NONE ROUT [Y0] [Y1] [E0] [E1] [X0] LCR 0001 0011 0101 0111 1001 1011 1101 1111
1 0		X0 X1 Y0 Y1 E0 E1 C0 C1

1.

Fig. 18 : OPDI : Calculation Instruction with Direct Addressing.

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Bit	Field	Operations and Codes
31 30 29 28 27	OP CODE	01110
26 25 24	L SRC	000 001 010 011 100 101 110 111 [X0] [X1] [Y0] RIN T [E1] [C0] [C1]
23	SL	0-LBUS / 1-P
22	SR	0-RBUS / 1-A
21 20 19 18 17	ALU CODE	cf. Special Table
16	ALU DST	0-F / 1-A
15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0	IMMEDIATE VALUE (R-BUS)	MSB

Fig. 19 : OPIM : Calculation Instruction with Immediate Operand.



Bit	Field	Operations and Codes
31 30 29 28 27	OP CODE	01111
26 25 24	L SRC	000 001 010 011 100 101 110 111 X – Y RIN T E – C
23	SL	0-LBUS / 1-P
22 21	ALU CODE	00 01 10 11 ASR LSL LSR ROR
20 19 18 17	SHIFT VALUE	NOTE : When LSR, ASR, ROR 0000 0001 1111 0 1 15
16	ALU DST	0-F / 1-A
15 14 13 12 11 10 9 8 7 6 5 4	LBUS DIRECT ADDRESS	MSB LSB
3		
2		
0	l	

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Fig. 20 : ASR, LSL, LSR, ROR, Shift Instructions.

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Fig. 21.	ig. 21 : BRI : Branch Immediate Instruction.			
Bit	Field	Operations and Codes		
31 30 29	OP CODE	100		
28	BRA	0-IR, 1-RAS		
27	FT	0-FALSE, 1-TRUE		
26 25 24 23	COND	CF Special Table		
22	SVPC	0-NO SVPC, 1-PC \rightarrow RAS*		
21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6	BRANCH ADDRESS	MSB LSB		
5 4	АХ	00 01 10 11 + 0 + 1 1		
3 2 1	Z DST	000 001 010 011 100 101 110 111 NONE – [Y0] [Y1] – – [X0] [X1]		
0	ZT	0 NO LOAD, 1-ZBUS \rightarrow T		

Fig. 21 : BRI : Branch Immediate Instruction.

* The PC write operation in X or Y RAM (defined by Z DST) is realized if the branching is really executed.



-				
Bit	Field	Operations and Codes		
31 30 29 28	OP CODE	1010		
27	FT	0-FALSE, 1-TRUE		
26 25 24 23	COND	CF Special Table		
22	SVPC	0-NO SVPC, 1-PC \rightarrow RAS*		
21 20				
19	RTI	0-NO RTI, 1-RAS \rightarrow PC		
18 17 16				
15 14 13 12	BRANCH SOURCE	000 001 010 011 100 101 110 111 NONE F A B T – – –		
11 10 9 8 7 6				
5 4	AX	00 01 10 11 + 0 + 11		
3 2 1	Z DST	000 0001 010 011 100 101 110 111 NONE – [Y0] [Y1] – – [X0] [X1]		
0	ZT	0-NO LOAD, 1-ZBUS \rightarrow T		

Fig. 22 : BRC : Branch Computed Instruction.

* See BRI.

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Fig. 23 : SVR : Data Transfer Instruction.

Bit	Field	Operations and Codes
31 30 29 28 27 26	OP CODE	011000
25 24 23 22	Z SRC	0000 0001 0010 0011 0100 0101 0110 0111 X0 X1 Y0 Y1 E0 E1 C0 C1 1000 1001 1010 1011 1100 1101 1110 1111 AMR LC A F D STA B -
21 20 19 18 17 16		
15 14 13 12 11 10 9 8 7 6 5 4	ZBUS DIRECT ADDRESS	MSB LSB
3 2 1	Z DST	000 001 010 011 100 101 110 111 NONE ROUT Y AMR E STR X -
0	ZT	0-NO LOAD, 1-ZBUS \rightarrow T



Bit	Field	Operations and Codes
31 30	OP CODE	11
29 28 27	J DST	000 001 010 011 100 101 110 111 AMR LCD Y0 ⁽³⁾ Y1 ⁽³⁾ CRR EN ⁽¹⁾ EF NONE ⁽²⁾
26 25 24	K DST	000 001 010 011 100 101 110 111 X0 X1 LCI-LCR NONE E0 E1 C0 C1
23 22	MODE	00 01 10 11 - REAL DBPR CPLX
21	SAT	0 NO SATURATION MODE 1 SATURATION MODE
20	AD0F	0 NO INVERSION 1 INVERSION LSB ADDRESS X/Y RAM
19 18 17 16 15 14 13 12	J CONSTANT	J7 If JDEST = EN see table below. J0
11 10 9 8 7 6 5 4 3 2 1 0	K CONSTANT	11 If KDEST = X0 or KDEST = X1 and K7 = 0 then XRAM Normal Mode K7 = 1 then XRAM Circular Addressing Mode

1

Fig. 24 : INI : Initialization and Control Instruction.

* EN (Enable) code (101) is a multi-function condition permitting independant programming of RDYOIN and SIM flags, and STA register bit EI in J field of the INI instruction.

Notes : 1) If JDST = EN and :

Ĵ7 J6	EIMB = no change EIMB = 0 EIMB = 1	1	X 0	: EI = no change : EI = 0 : EI = 1	J2 0 1	0	: SIM = no change : SIM = 0 system bus Intel : SIM = 1 system bus Motorol	J0 0 : RDYON = no change 1 : RDYON = 1
2) If JD9	ST = NONE and J7 = 1	1 ther	ı low	v Power mode.				

2) If JDST = NONE and J7 = 1 then low Power mod
3) If JDST = Y0 or JDST = Y1 and J7

0 : Y RAM normal mode

1 : Y RAM circular addressing mode.

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5.2 ALU CODES

MNEMO	Function	SR	SI	CR	CI	z	OV F	MO VF	AO VF	Code (I17-I21)
ADD	A + B	*	*	*	*	*	*	*	*	00010
ADDC	A + B + CARRY	*	*	*	*	*	*	*	*	00011
ADDS	B + A/16	*	*	*	*	*	*	*	*	00001
ADDX	B + A* (COMPLEX CONJUGATE)	*	*	*	*	*	*	*	*	01010
AND	A·B	*	*	0	0	*	0		*	01110
ASL		*	*	*	*	*	*		*	01011
ASR	CARRY	*	*	*	*	*	0		*	01111
CLR	CLEAR	0	0	0	0	_ 1	0	<u> </u>	0	10011
СОМ	COMPLEMENT A	*	*	0	0	*	0		*	10110
СОМ	COMPLEMENT B	*	*	0	0	*	0		*	11000
LCCR	LBUS -> CCR	*	*_	*	*	*	*	*	*	01001
LSL	CARRY - 0	*	*	*	*	*	Ō		*	11011
LSLB	LSL BYTE	*	*	*	*	*	0		*	11001
LSR	0 CARRY	*	*	*	*	*	0		*	00111
LSRB	LSR BYTE	*	*	*	*	*	0		*	11010
NOP										00000
OR	A A B	*	*	0	0	*	0		*	01101
RCE	EXECUTE RC	*	*	*	*	*	*	*	*	10001
RCER	EXECUTE RC / LOAD NEW CODE	*	*	*	*	*	*	*	*	10000
RCR	LOAD RC									10010
ROR	CARRY	*	*	*	*	*	0		*	10111
SBC	A + B + CARRY	*	*	*	*	*	*	*	*	00101
SBCR	Ā + B + CARRY	*	*	*	*	*	*	*	*	01000
SET		1	1	0	0	0	0		0	11100
SUB	A + B + 1	*	*	*	*	*	*	*	*	00100
SUBR	Ā + B + 1	*	*	*	*	*	*	*	*	00110
TRA	TRANSFER A	*	*	0	0	*	0		*	10100
TRA	TRANSFER B	*	*	0	0	*	0		*	10101
XOR	A⊕B	*	*	0	0	*	0		*	01100
SUBS	B + A/16 + 1	*	*	*	*	*	*	*	*	11101

Notes: 1. A B refer to ALU inputs (respectively LSIDE, RSIDE) not to accumulators A/B. 2. In ASL the OVF bit is equivalent to exclusive OR of bit 14 and 15.



5. 3. TEST CONDITIONS

True Condition	False Condition	Code
BE3	No BE3	0100
BE4	No BE4	0010
BE5	No BE5	0011
BE6	No BE6	0001
Branch Always	Branch Never	0000
BS0	No BS0	1100
BS1	No BS1	1101
BS2	No BS2	1110
CI	No Cl	1010
CR	No CR	0110
MOVF	No MOVF	1011
OVF	No OVF	0111
RDYOIN	No RDYOIN	1111
SI	No SI	1001
	No SR	0101
Z	No Z	1000

H

5.4. AMR AND STA REGISTERS

AMR (Access Mode Register)

8	7	6	5	4	3	2	1	0
EIMB	SE1	MASK	BA BE5	DTACK BE6	T M	SB CB	SL PS	SE0
STA (Status Register)								

15	14	13	12	11	10	9	8	7	6	5	43	2	1	0
SR	SI	CR	CI	Z	OVF	MOVF	AOVF	OVFM	EF	SAT	MODE	xc	YC	EI
	CCR							_			STR			

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CONDITION CODE REGISTER (CCR)

Name	Function	Description
SR	Sign Real	Set if the MSB of the ALU result is 1. Cleared otherwise.
SI	Sign Imaginary	Set if the MSB of the ALU imaginary result is 1 (in complex mode). Cleared otherwise.
CR	Carry Real	Set if a carry is generated out of the MSB of the result for arithmetic and shift operations. Cleared otherwise.
CI	Carry Imaginary	Set if a carry is generated out of the MSB of the imaginary part of the result for complex arithmetic and shift operations. Cleared otherwise.
Z	Zero	Set if the ALU result equals zero. In complex mode it is set if both real and imaginary parts are equal to zero.
OVF	Overflow	Set if there was an arithmetic overflow. This implies that the result cannot be represented in the operand size. In complex mode it is set for an overflow of either real or imaginary part. Cleared otherwise.
MOVF	Memorized Overflow	Set in the same conditions as overflow. Is cleared only when tested by a branch instruction.
AOVF	Advanced Overflow	Exclusive OR of bit 14 and 15 of the ALU. If there was an arithmetic overflow on half capacity (15 bits in real/complex mode, 31 bits in double precision mode). Is memorized and cleared by LCCR ALU instruction.
OVFM	Overflow Multiplier	Set if the multiplier has overflowed. Only meaningful for complex multiplication. Is memorized and cleared by LCCR ALU instruction.

STATE REGISTER (STR)

Name	Function	Description
EF	Empty FIFO	Set if FIFO is empty. Cleared otherwise.
SAT mode	Saturation Flag	Set if the ST18930 is programmed in saturation mode. In this configuration, the processor will behave as follows : Positive overflow : ALU result forced to 7FFF Negative overflow : ALU result forced to 8000 This feature does not apply to double precision mode. This bit is cleared otherwise.
MODE (2bits)	Operating Mode	Define a real (01), complex (11) or double precision (10) mode.
XC	XRAM Circular	Circular addressing mode flag for XRAM. (see 3.3.3)
YC	YRAM Circular	Circular addressing mode flag for YRAM. (see 3.3.3)
EI	Enable Interrupt	Enable interrupt flag (IT0, IT1, IT2).



6. ELECTRICAL SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	- 0.3 to 7.0	V
Vin	Input Voltage	- 0.3 to 7.0	V
Т	Operating Temperature Range	0 to 70*	°C
T _{stg}	Storage Temperature Range	– 55 to 150	°C
P _{Dmax}	Maximum Power Dissipation	0.8	w

Stresses above those hereby listed may cause permanent damage to the device. The ratings are stress ones only and functional operation of the device at these or any conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability Standard MOS circuits handling procedure should be used to avoid possible damage to the device.

With respect to VSS.

* Other temperature ranges also available on request.

DC CHARACTERISTICS

 V_{CC} = 5.0 V \pm 10 %, V_{SS} = 0 V, T_A = 0 to + 70 °C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	4.5	5	5.5	v
VIL	Input Low Voltage	- 0.3		0.8	V
VIH	Input High Voltage (all inputs except EXTAL)	2.4		Vcc	V
VIHE	Input High Voltage EXTAL	2.7		Vcc	V
	Input Leakage Current (1) - (3)	- 10		+ 10	μΑ
linEX	Input Leakage Current on EXTAL (3)				
Vон	Output High Voltage (Iload = - 300 µA, except DTACK)	2.7			V
VoL	Output Low Voltage (Iload = 2 mA)			0.5	V
PD	Power Dissipation		0.35		w
Ppd	Power Dissipation Low Power Mode		10		mW
Cin	Input Capacitance		10		pF
	Three State (off state) Input Current (2)	- 20		+ 20	μA

Notes: 1. ID0-ID31, RESET, BE3, BE4, BE5 and HALT, NOP, CC (for ST18931).

2. D0-D15, AD0-AD7, BE5, BE6 and IA0-IA15, CAD-CAB (for ST18931).

3. Test conditions : $V_{in} = 0.4$ V and $V_{in} = V_{DD}$.



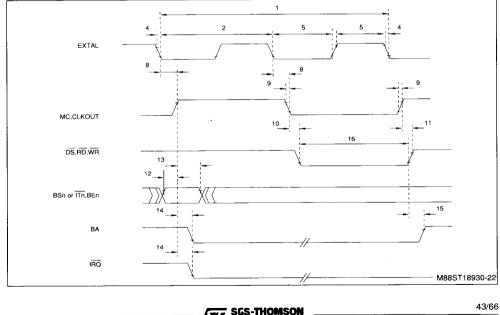
AC ELECTRICAL SPECIFICATIONS - CLOCK AND CONTROL PINS TIMING (ST18931 only) $(V_{CC} = 5.0 \text{ V} \pm 10 \%, \text{ T}_{A} = 0 \text{ to } +70 \degree \text{C}, \text{ see figure 9.1.})$

 t_r , $t_f \le 5$ ns for inputs signals

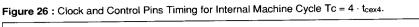
OUTPUT LOAD = 50 pF, DC Characteristics | load BEFEBENCE LEVELS $V_{II} = 0.8 V$ $V_{IH} = 2.4 V$ $V_{OI} = 0.8 V V_{OH} = 2.4 V$

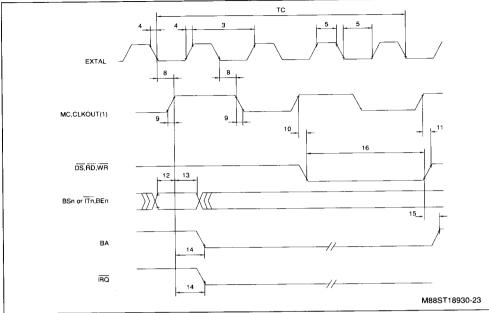
 $T_{C} = 80 \text{ ns} T_{C} = 100 \text{ ns} T_{C} = 160 \text{ ns}$ Unit N° Symbol Parameter Min. Max. Min. Max. Min. Max. 160 T_C 80 320 100 400 640 ns 1 Machine Clock Cycle Time 200 External Clock Cycle Time (T_C = 2 x tcex) 50 ns 2 tcex2 160 External Clock Cycle Time (T_C = 4 x tcex) 40 ns 3 tcex4 External Clock Fall and Rise Time 5 5 5 ns tcext 4 24 30 16 24 EXTAL High or Low 16 20 ns 5 tcexw 20 RESET to EXTAL Low Set-up and Hold Time 20 20 ns 6 trst 8 8 Тc **RESET** Width Low 8 7 trstd 25 25 25 EXTAL to CLKOUT Low and High Delay пs 8 tcod CLKOUT, MC, DS, RD, WR, R/W Fall and Rise 2 5 9 tcot 2 5 2 5 ns Time CLKOUT, High to DS, RD, WR Low - 3 з - 3 3 - 5 5 ns 10 tdsl - 5 5 - 3 - 3 11 tdsh CLKOUT, High to DS, RD, WR High 3 з ns Control Input Set-up Time 20 20 20 ns 12 tsc (BS0-BS2, IT0-IT2, BE3-BE6) 10 10 10 ns Control Input Hold Time 13 thc (BS0-BS2, BE3-BE6, IT0-IT2) CLKOUT High to Control Output Low (IRQ,BA) 25 25 25 ns 14 tdic 25 25 CLKOUT High to Control Output High (BA) 25 ns 15 tdhc 70 RD, WR, DS Pulse Width 32 42 ns 16

Figure 25 : Clock and Control Pins Timing for Internal Machine Cycle Tc = 2 x External Clock Cycle Time (tcex) and frequency of CLKOUT equal EXTAL freq /2.

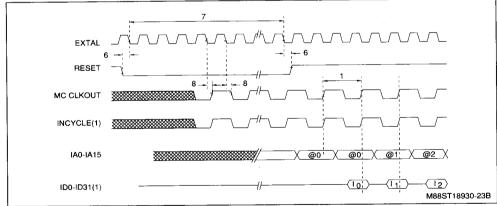


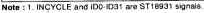
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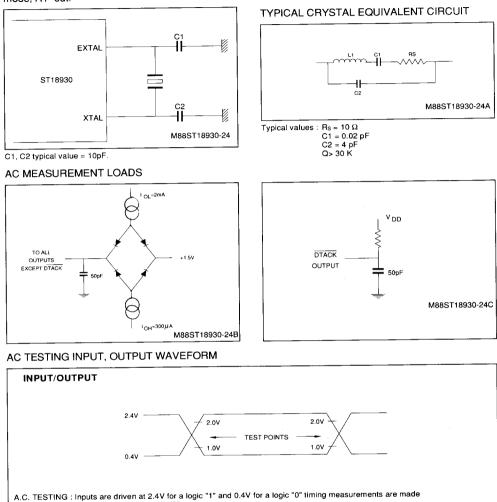




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INTERNAL CLOCK OPTION

A crystal can be connected across XTAL and EXTAL functioning in the parallel resonant fundamental mode, AT-cut.



at 2V for a logic "1" and at 1.0V for a logic "0".

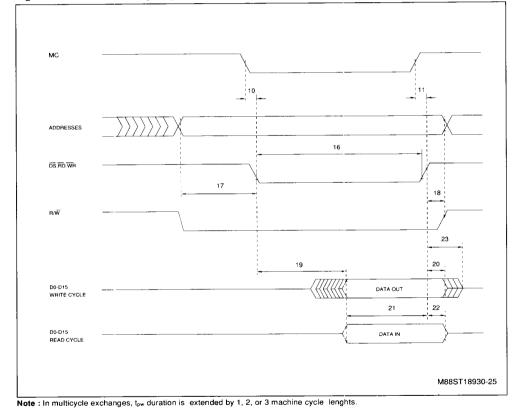


AC ELECTRICAL SPECIFICATIONS - LOCAL BUS TIMING

 $(V_{CC} = 5.0 \text{ V} \pm 10 \text{ \%}, T_A = 0 \text{ to } +70 \text{ °C})$

	N° Symbol		T _c =	T _C = 80 ns			T _c = '		
N°		Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
16	tew	RD, WR, DS Pulse Width	32		42		70		ns
17	tarw	Address Valid to WR, DS, RD Low	20		30		55		ns
18	t _{AH}	Address and R/W Hold Time		5		5		5	ns
19	toow	Data Delay Time, Write Cycle		25		25		30	ns
20	toнw	Data Hold Time, Write Cycle		5		5		5	ns
21	t _{DSR}	Data Set-up Time, Read Cycle	15		15		20		ns
22	t _{DHR}	Data Hold Time, Read Cycle				5		5	ns
23	t _{DDZ}	Data Valid to Z State		20		20		20	ns

Figure 28 : Local Bus Timing Diagram.



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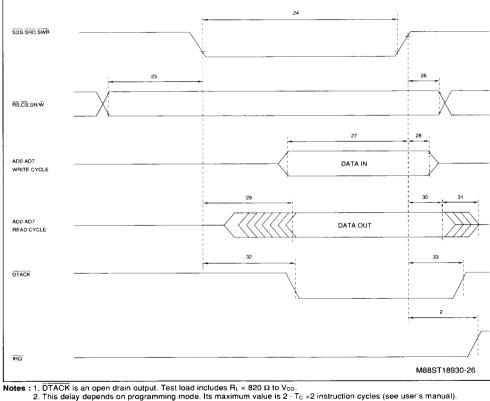
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AC ELECTRICAL SPECIFICATIONS - SYSTEM BUS TIMING

 $(V_{CC} = 5.0 \text{ V} \pm 10 \%, \text{ T}_{A} = 0 \text{ to } +70 \text{ °C})$

[T _c =	80 ns	$T_{C} = $	100 ns	Tc = '	160 ns	
N°	N° Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
24	tspw	SDS, SRD, SWR Pulse Width	30		40		60		ns
25	tsaw	SR/W, CS, RS Set-up Time	15		15		15		ns
26	t _{sah}	SR/W, CS, RS Hold after SDS High	5		5		5		ns
27	tsdsw	Data Set-up Time, Write Cycle	15		15		15		ns
28	t _{SDHW}	Data Hold Time, Write Cycle		5		5		5	ns
29	t _{SDDR}	Data Delay Time, Read Cycle		25		30		30	ns
30	tSDHR	Data Hold Time, Read Cycle	5		5	_	5		ns
31	t _{SDZR}	SDS, SRD High to Z State		25		25		30	ns
32	tDSLDT	SDS Low to DTACK Low		20		20		20	ns
33	t _{DSHDT}	SDS High to DTACK Desactivated (1)		20		20		20	ns

Figure 29 : System Bus Timing Diagram for Tranfer of 1 Byte.





		Parameter	T _c =	80 ns	$T_{C} = 1$	100 ns	T _c =	160 ns	
N°	N° Symbol		Min.	Max.	Min.	Max.	Min.	Max.	Unit
34	t _{INCH}	MC High to INCYCLE High Time	- 5	+ 5	- 5	+ 5	- 5	+ 5	ns
35	tINCL	MC High or Low to INCYCLE Low Time	- 5	+ 5	- 5	+ 5	- 5	+ 5	ns
36	tiad	Instruction Address Delay Time		20		20		30	ns
37	tian	Instruction Address Hold Time	5		5		5		ns
38	tIDS	Instruction Data Set-up Time	30		30		40		ns
39	t _{IDH}	Instruction Data Hold Time	5		5		5		ns
40	tCAD	External CROM Address Delay Time		25		25		30	ns
41	t _{CAH}	External CROM Address Hold Time	5		5		5		ns
42	t _{CDS}	External CROM Data Set-up Time	15		15		20		ns
43	t _{CDH}	External CROM Data Hold Time	5		5		5		ns
44	t _{HS}	HALT Set-up Time	20		20		20		ns
45	tнн	HALT Hold Time	10		10		10		ns
46	tcsp	MC High to Data Bus		20		30		40	ns
47	tcsH	MC High to Data Bus	5		5		5		ns

AC ELECTRICAL SPECIFICATIONS - INSTRUCTION INTERFACE TIMING (ST18931 only) (V_{CC} = 5.0 V \pm 10 %, T_A = 0 to +70 $^{\circ}C$)

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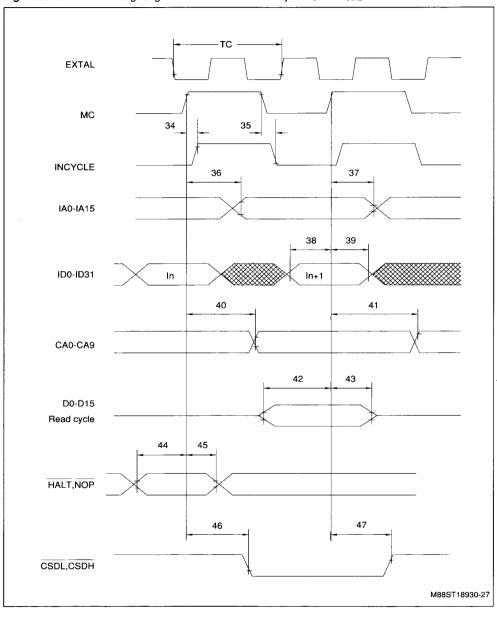


Figure 30 : ST18931 Timing Diagram for Internal Machine Cycle $T_C = 2 \cdot t_{cex2}$.

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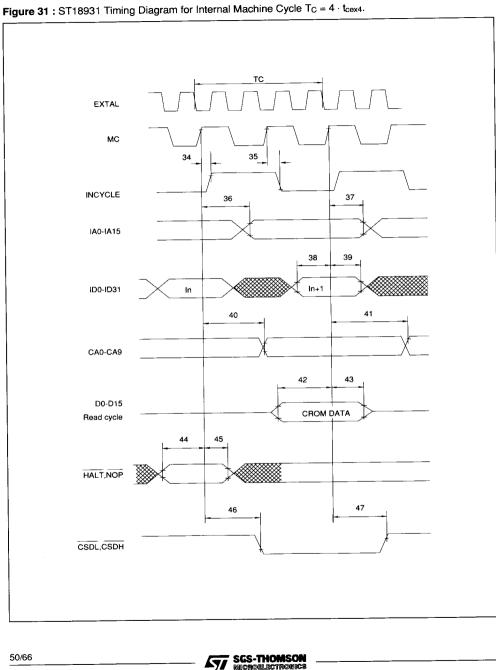
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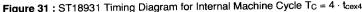
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MICROFIERTRONCS





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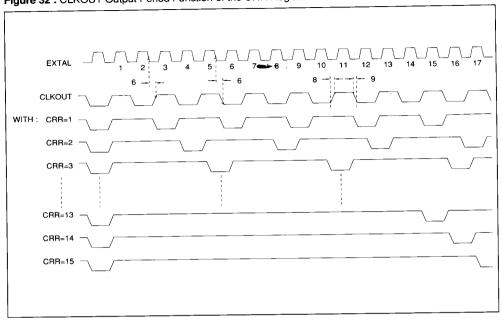


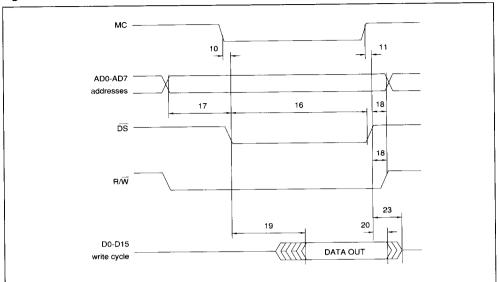
Figure 32 : CLKOUT Output Period Function of the CRR Register Value.

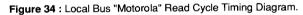


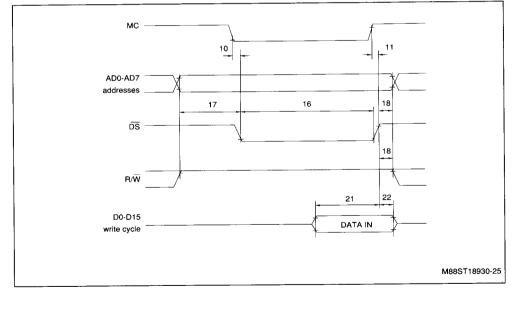
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Figure 33 : Local Bus "Motorola" Write Cycle Timing Diagram.







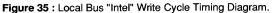
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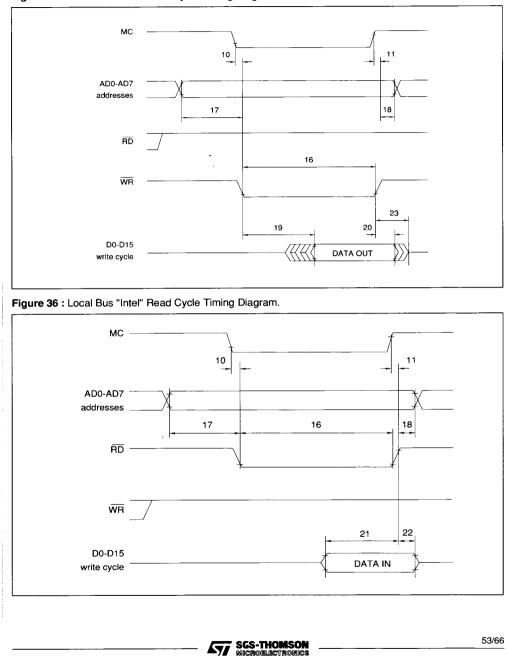
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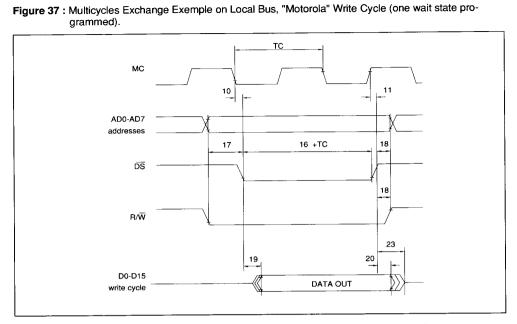




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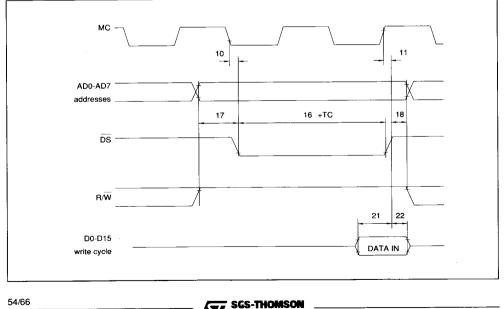
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Figure 38 : Multicycle Exchange Exemple on Local Bus, "Motorola" Read Cycle (one wait state programmed.



MICROFLECTRONICS

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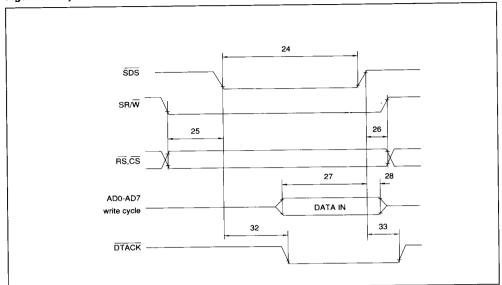
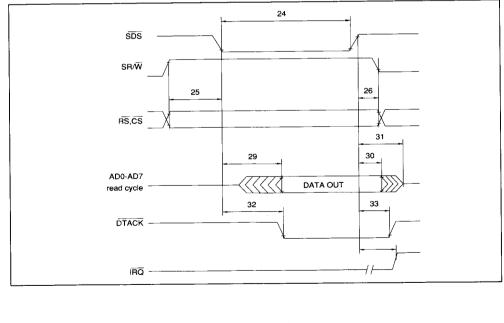


Figure 39 : System Bus : "Motorola" Write Cycle Timing Diagram.





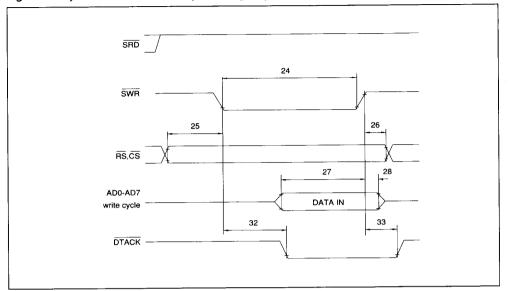
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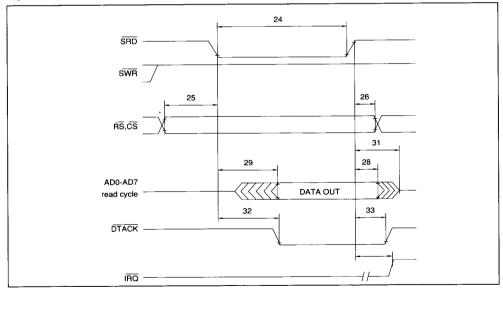
OFLECTROMICS

ST18930/31

Figure 41 : System Bus : "Intel" Write Cycle Timing Diagram.





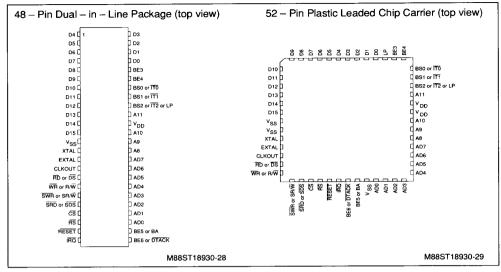


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7. PIN CONNECTIONS



1. ST18930 (top view)

	1	2	3	4	5	6	7	8	9	10	11	12	13
A	ID28	ID31	IA15	IA12	IA10	IA7	iA6	IA5	IA2	IAO	BE4	BS0	TIAH
8	ID25	1D26	ID29	IA14	IA11	IA8	vss	144	IA1	BE5/BA	BE3	BS1	CA0
с	ID22	ID23	1D27	ID30	IA13	IA9	VDD	iA3	BE6 DTACK	САЭ	BS2	NOP	CA1
D	ID19	ID21	ID24					RESET	CA2	CA4			
Е	ID17	ID18	1D20								САЗ	CA5	CA6
F	ID14	ID15	1D16								CA7	CA8	A 8
G	ID13	vss	VDD				ST 1893 PGA 121				VDD	vss	A9
н	ID12	ID11	ID10	A					AD0	A11	A10		
J	ID9	ID8	ID6								AD4	AD2	AD1
ĸ	ID7	ID5	102	N/C							RS	AD5	AD3
L	ID4	ID1	DO	D3	D3 D7 D11 VSS CSDH MC EXTAL							AD7	AD6
м	ID3	D1	D4	D6	D9	D12	vss	CSDL	₽∕₩	IN CYCLE	сс	SR/₩	टड
N	ID0	D2	D5	D8	D10	D13	D14	D15	DS	CLKOUT	LP	XTAL	ĪRQ

M88ST18930-30



ST18930/31

ORDERING INFORMATION

Part Number	Temperature Range*	Package
ST18930CP/PXXX**	0 to 70 ℃	48 Pin Plastic DIL
ST18930CFN/PXXX**	0 to 70 ℃	52 Pin Plastic LCC
ST18931CR	0 to 70 ℃	121 Pin Grid Array

* For extended temp. range, please consult your sales office.

** XXX is the specific number associated to a customer code.

* The ST18930/31 is available in 80 ns, 100 ns cycle time versions. Please consult your sales office.

SOFTWARE TOOLS

ST18930 SP-PC	Software Package for PC Including Macroassembler Functionnal Stimulator Linker
ST18930 SP-VMS	Same Software Package for VAX Machines under VMS
ST18930 SPC-PC	Same Software with C-compiler for PC
ST18930 SPC-VMS	Same Software with C-compiler for VAX

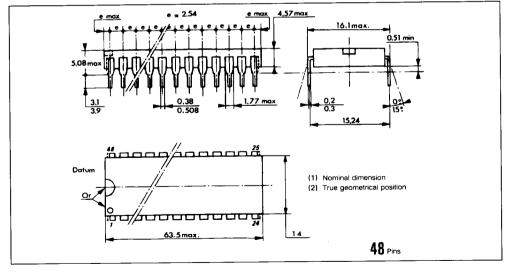
HARDWARE TOOLS

ST18930 EMU	Stand-alone Emulator	
ST18930 HDS-1	Hardware Development System 110 V Power Supply	
ST18930 HDS-0	Hardware Development System 220 V Power Supply	
ST18930 EPR48	EPROM Simulation Module for ST18930 in 48 Pins DIP	
ST18930 EPR52*	EPROM Simulation Module for ST18930 in PLCC52	

* Consult your sales office for availability.

9. PACKAGE MECHANICAL DATA

48 PINS - PLASTIC DIP

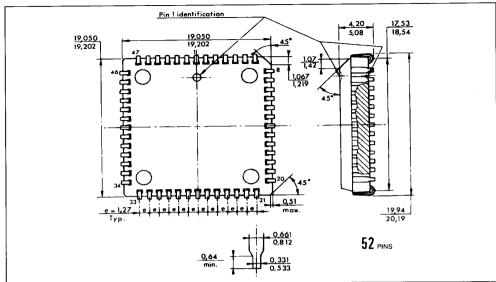


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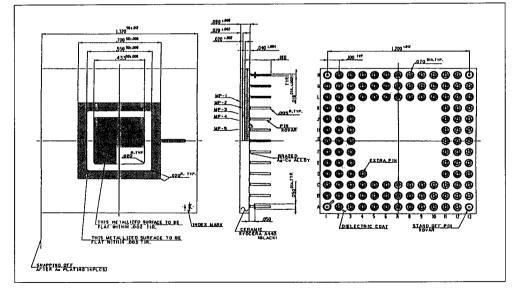
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52 PINS - PLASTIC LEADED CHIP CARRIER



121 PINS - PIN GRID ARRAY CERAMIC





APPENDIX A

BENCHMARK

	Execution Time (nsec)	Memory Size (words) Prgm + coef	Number of Clock Cycles	Clock Freq. (MHz)	Word Size (bits)	Coefficient Size (bits)	Result Size (bits)
20 Tap FIR Filter	2400	6 + 20	24	10	32	16	16
64 Tap FIR Filter	6800	6 + 64	68	10	32	16	16
67 Tap FIR Filter	7100	6 + 67	71	10	32	16	16
8 Pole Cascaded Canonic Biquad IIR Filter (4X)	2800	13 + 20	23	10	32	16	16
8 Pole Cascaded Canonic Biquad IIR Filter (5X)	2400	13 + 20	23	10	32	16	16
8 Pole Cascaded Transpose Biquad IIR Filter	3300	15 + 20	33	10	32	16	16
Dot Product	600	6	6	10	32	16	16
Matrix Mult 2X2 Times 2X2	1400	14	14	10	30	16	16
Matrix Mult 3X3 Times 3X1	1500	15	15	10	32	16	16
M-to-M FFT 64 Point	121300	203 + 388	1213	10	32	16	16
256 Point	757300	349 + 764	7573	10	32	16	16

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APPENDIX B

DEVELOPMENT TOOLS

DEVELOPMENT PROCESS

The development process of a digital signal processing application using the ST18930 or ST18931 is supported by a complete range of dedicated software and hardware tools which includes macroassembler, linker, simulator, C compiler and optimizer (respectively ST18930SP or ST18930SPC), standalone emulation card ST18930EMU, multiprocessor hardware development system ST18930HDS, EPROM emulation module, ST18930EPROM.

SOFTWARE TOOLS

All the development softwares run on the most common computers, such as IBM-PC[®] or AT[®], under MS-DOS[®] or VAX[®], VMS[®], UNIX[®] or ULTRIX[®] operating systems.

The macroassembler supports conditional assembly, high level language facilities for loop definition and generates all the files for simulation, emulation and PROM programming.

The functional simulator provides step by step execution, break on address and data values, access to all internal registers and interface to I/O files (ADC, DAC, test inputs).

The linker provides modular programming facilities.

The library consists of macros, basic DSP routines etc... and provides additional help to user's for their applications.

The C language compiler offers high-level language facilities which meets the advanced requirements (parallelism, pipe-line, three computation modes, 32-bit instruction set) of the ST18930/31.

HARDWARE TOOLS

All the hardware tools are designed to provide ease of use and minimum learning time by utilizing menu driven and DSP specific emulation features.

ST18930 EMU and ST18930 HDS have in common :

- Full speed emulation of ST18930 and ST18931
- Use of internal, external or application clock
- 20 breakpoints (stops at defined addresses)
- 8 complex breakpoints (stop after N address X and M address Y)
- Realtime trace of internal resources
- Emulation probes (for ST18930 or ST18931)

- Menu driven operation (about 100 commands)
- _ Resident Assembler/Disassembler with full screen editor
- _ Symbolic debbuging
- _ Direct link with PROM programmers

Emulator specific features.

The ST18930EMU is a low cost, stand-alone emulator providing advanced emulation features such as real-time trace. It can be driven via a RS232C link by a terminal or an IBM-PC^R and offers :

- 8 K program memory (expandable to 64 K)
- _ 2 K x 16-bit data RAM
- " A wire-wrapping area
- Full speed 100 ns cycle emulation
- 2 RS232C serial ports
- _ Complex conditions break-points

Hardware development station features :

The ST18930 HDS is a hardware development station, aimed at the development of multiprocessor applications. Up to four pairs of emulator boards, and logic analyser boards can be combined to match exactly the user needs :

- CMOS memory for backup of configuration
- 64 K x 32 program memory
- _ 4 K x 16 data RAM
- A logic analyser with :

* 2 K x 19 bit for trace of ST18930/31 bus and 15 external inputs

* Synchronous analyzer on program and local buses

* Asynchronous analyzer on system bus or external inputs

* Triggering conditions (Address bus with count, data bus external branch inputs, mailbox exchanges, external inputs).

EPROM module.

The ST18930EPROM is a small-sized module which uses the perfect compatibility between ST18930 and ST18931. The module uses a ST18931 and fast EPROM memories to emulate in real time a ROM masked SR18930 during prototyping or field tests to minimize hardware developments. The module is plug and function compatible with ST18930 pin out.



APPENDIX C

MASKING INFORMATION

The information required by SGS-THOMSON Microelectronics to realize a customer masked version of the ST18930 are provided below.

The files for masking must include program ROM content and coefficient ROM content. They can be

VERIFICATION MEDIA

All original pattern media are filed for contractual purpose and are not returned. A computer listing of the ROM content code will be generated and returned to the customer with a listing verification form. The listing should be carefully checked and the ap-

VERIFICATION UNITS

Ten engineering samples containing the customer ROM patterns will be sent for program verification.

transferred on EPROMS, 5" 1/4 floppy disks, magnetic tapes (VAX/VMS format) or by link to SGS-THOMSON Microelectronics. This must be done in conjunction with your local sales office or representative indications.

proval form completed, signed and returned to SGS-THOMSON. The returned verification form is the contractual agreement for generation of the customer masks and batch manufacturing.

These samples will be engineering samples and must be kept by user as reference parts.



DIGITAL SIGNAL PROCESSOR CUSTOMER ORDERING SHEET

			N				63/66
* See	your local sales office the differen	t options.					
Cus	tomer Contact Name		Date			Signature	
FOF	R A SHIPMENT PERIOD O	F:					
STA	ART OF PRODUCTION DA	TE :					
YEA	ARLY QUANTITY FORECA	STED :					
				0	DIVISIO • ÷ 2 • ÷ 4	N OF EXTAL	
0	OTHER*			0		N OF CLOCK OWER MODE	
0	MAGNETIC TYPE			0	LOW PO	OWER ON BS	2 PIN
0	5 1/4" FLOPPY						
О	EPROMS			0	WATCH	DOG	
ΡΑΤ	TERN MEDIAS	:		OPTI	ON	:	
				PHO	NE	:	
CUS	STOMER'S MARKING	:		ADDF	RESS	:	
CON	MMERCIAL REFERENCE*	:		сом	PANY	:	

APPENDIX D

SUMMARY OF RESOURCES PER FUNCTION

OPERATING MODES

Symbol	Function	Resource	Paragraph Nb
MODE	2-bit register defining the operating mode (real/complex/double precision)	Access Mode Register	3.2

OPERATING UNIT

Symbol	Function	Resource	Paragraph Nb
ALU	2 Port 16-bit Arithmetic Logic Unit. 5 Possible Sources. 4 Possible Destinations. 30 ALU Codes Works on 32-bit. Data in 2 Machines Cycles.	Arithmetic Logic Unit	3. 2. 1
D	ALU Output Register	· · · · · · · · · · · · · · · · · · ·	
BS	Variable 0 – 15-bit right shift, left shift, right rotation barrel shifter.	Barrel Shifter	3. 2. 2
MULT	16 X 16 \rightarrow 32 parallel pipeline multiplier + 16-bit adder/substractor , used in complex Multiplications.	Pipeline Multiplier	3. 2. 3
M, N	2 X 16-bit registers containing multiplier operands.		
P	2 X 16-bit register containing multiplier result.		
STA	16-bit register containing status of ALU, mode, status of address calculation units, enable interrupt flag.	Status	3. 2. 4
STR	7-bit register included in STA.	Status	3. 2. 4
CCR	9-bit register included in STA.	Status	3. 2. 4
A	2 x 16-bit accumulator.	Accumulators	3. 2. 4
В	2 x 16-bit accumulator.		
F	4 x 16-bit first in first out register.	Fifo	3. 2. 4
EF	Flag. Indicates that the Fifo is empty; can be set by software.	Empty Fifo	
RC	6-bit register allowing replacement of ALU operation code by a data coming from L-BUS.	Replace Code Register	3. 2. 4
Т	2 x 16-bit register providing direct transfer between L-BUS and Z-BUS.	Transfer Register	3. 2. 4
SAT	Flag indicates saturation mode.	Saturation	3. 2. 4

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DATA MEMORY BLOCK

Symbol	Function	Resource	Paragraph Nb
XRAM YRAM	192 x 16-bit (X) and 128 x 16-bit (Y) Random Access Memories	Data RAMs	3. 3. 1
CROM	512 x 16-bit read only memory containing coefficients or constants.	Data ROM	
XACU YACU	Arithmetic units providing address incrementation, decremen- tation and automatic loop. XACU is dedicated to XRAM. (8 bits) YACU is dedicated to YRAM. (7 bits)	Address Calculation Units	3. 3. 2
ECACU	12-bit arithmetic unit providing incrementation, decrementation of address. Shared by CROM and ERAM (external RAM).		
XC YC	Flag indicates the circular addressing mode for XRAM. Flag indicates the circular addressing mode for YRAM.	XRAM Circular Flag YRAM Circular Flag	3. 3. 3
X0, X1 X	2 x 8-bit registers used for indirect addressing of XRAM Supplementary register used for circular addressing.	Pointers	3. 3. 4
Y0, Y1 Y	2 x 7-bit registers used for indirect addressing for YRAM. Supplementary register used for circular addressing.		
C0, C1	2 x 9-bit register used for indirect addressing of CROM.		
E0, E1	2 x 12-bit registers used for indirect addressing of ERAM.		

CONTROL BLOCK

Symbol	Function	Resource	Paragraph Nb
IROM	3072 x 32-bit word read-only-memory containing program code and immediate data for ST18930 (ref section 6. 6 for ST18931)	Instruction ROM	3. 4. 2
IR	32-bit register containing instruction.	Instruction Register	
PC	Register containing address of program memory.	Program Counter	3. 4. 3
SEQ	The sequencer can test directly 16 conditions programmed on a high or low state and the sequencer controls next program address defined by BRANCH, subroutine call, next instructions or interrupt.	Sequencer	3. 4. 1
RAS	2 x 16-bit register for saving programm counter in case of subroutine call or interrupt.	Return Address Stack	3. 4. 1
LC	15-bit register containing a control word for automatic loop. It is divided into the following sub-registers.	Loop Counter	3. 4. 4
LCI LCR LCD	 4-bit register containing the number of instructions to be executed in the loop. 8-bit register containing the number of loops. 3-bit register containing the number of instructions between declaration and start of the loop. 		
	Prevents locked states for ST18930 only.	Watchdog Circuit	3. 6. 3
LP	Freezes the circuit operation.	Low Power Mode	3. 6. 4



ST18930/31

INPUT/OUTPUT BLOCK

Symbol	Function	Ressource	Paragraph Nb
IT	Interrupt routine start.	Interrupts	3. 5. 1
AMR	8-bit register defining the access mode on the 2 external buses (local and system).	Access Mode Register	3. 5. 7
RIN ROUT	3 x 8-bit shift registers. Mailbox input. 3 x 8-bit shift registers. Mailbox output.	Input Registers Output Registers	3. 5. 6
RDYOIN	Flag used in the protocol to indicate witch processor has access to the mailbox.	Read Out Internal	3, 5, 5
CRR	4-bit register defining EXTAL to CLKOUT frequency ratio.	CLK Rate Register	3. 6. 1
SĪM	Flag used to define access mode on system bus.	System Intel Motorola	3. 5. 7

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